



## Asymmetric 10GEPON ONU SFP+ Transceiver *Preliminary*

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**SOEX3667-PSIGA**

### **FEATURES**

- Single fiber bi-directional data links Asymmetric TX 1.25Gbps/RX10.3125Gbps application
- -40°C to 85°C operating case temperature
- Single 3.3V power supply
- SFP+ package with SC Receptacle connector
- Hot-pluggable capability
- High power 1310nm DML DFB LD and high sensitivity 1577nm APD
- Support 20km transmission distance with SMF
- CML compatible data input/output interface
- Low power dissipation
- Low EMI and excellent ESD protection
- Digital diagnostic monitor interface
- RoHS compliance for SOEX3667-PSIGA

### **APPLICATIONS**

- Asymmetric 10GEPON PRX30 ONU with 15~29dB attenuation range

### **STANDARDS**

- Complies with SFP+ MSA (SFF-8431)
- Complies with IEEE 802.3av
- Complies with SFF-8472 Rev 10.2
- Complies with FCC 47 CFR Part 15, Class B
- Complies with FDA 21 CFR 1040.10 and 1040.11, Class I
- Complies with FDA 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated June 24, 2007

**ABSOLUTE MAXIMUM RATING**

Parameter	Symbol	Min.	Max.	Unit	Notes
Storage Ambient Temperature	$T_{STG}$	-40	85	°C	
Operating Case Temperature	$T_c$	-40	85	°C	
Operating Humidity	OH	5	95	%	
Power Supply Voltage	$V_{CC}$	-0.5	3.6	V	

**RECOMMENDED OPERATING CONDITION**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Operating Case Temperature	$T_c$	-40		+85	°C	
Power Supply Voltage	$V_{CC}$	3.13	3.3	3.47	V	
Power Supply Current	$I_{CC}$		290	450	mA	
Nominal upstream line rate			1.25		Gbps	
Nominal downstream line rate			10.3125		Gbps	

**TRANSMITTER OPTICAL CHARACTERISTICS**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Average Launch Optical Power	$P_{OUT}$	0.62	-	5.62	dBm	EOL, Launched into 9/125 $\mu$ m single mode fiber
Extinction Ratio	ER	9	-	-	dB	
Centre Wavelength	$\lambda$	1260	1310	1360	nm	
Spectral Width (-20dB)	$\Delta\lambda$	-	-	1	nm	
Side Mode Suppression Mode	SMSR	30			dB	
Burst on time	$T_{on}$			30	ns	
Burst off time	$T_{off}$			30	ns	
Transmitter and dispersion penalty	TDP			1.4	dB	
Eye Diagram	Compliant With IEEE Std 802.3ah™-2004					PRBS 2 <sup>7</sup> -1 test pattern @1.25Gbit/s

**TRANSMITTER ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Input Differential Impedance	$Z_{IN}$	90	100	110	$\Omega$	
Data Input Swing Differential	$V_{IN}$	200	-	1600	mV	
Burst_ENABLE	Burst Diabile	2.0	-	$V_{CC}$	V	
	Burst Enable	0	-	0.8	V	

**RECEIVER CHARACTERISTICS**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Notes
Optical Center Wavelength	$\lambda_c$	1575	-	1580	nm	
Receiver Sensitivity				-28.5	dBm	Measured with PRBS 2 <sup>31</sup> -1test pattern @10.3125Gbit/s, BER $\leq 1 \times 10^{-3}$ .
Receiver Overload		-10			dBm	
Receiver reflectance				-12	dB	
LOS De-Assert		-45			dBm	
LOS Assert				-29.5	dBm	
LOS Hysteresis		0.5		6	dB	
Data Output Swing Differential	$V_{OUT}$	340	-	850	mV	
LOS	High	2.4	-	$V_{cc}$	V	
	Low	0	-	0.4	V	

**PIN DESCRIPTION**

PIN	Name	Description	Notes
1	VeeT	Module Transmitter Ground	
2	TX Fault	Module Transmitter Fault	Low: normal; High: abnormal
3	TX BURST	Transmitter Burst Enable	TTL Input, Low: transmitter on
4	MOD-DEF2	Module Definition 2	2 wire serial ID interface, SDA
5	MOD-DEF1	Module Definition 1	2 wire serial ID interface, SCL
6	Mod_ABS	Module Absent	Connected to VeeT or VeeR in the module
7	TX_SD	Tx Transmitter State Indication	TX_Indication Assert When Transmitter ON
8	Rx_SD	Receiver Signal Indication	High: signal detected; Low: loss of signal
9	NC/P_Down	NC/ Module power down, Putting the module in the power saving mode	Active Low
10	VeeR	Module Receiver Ground	
11	VeeR	Module Receiver Ground	
12	RD-	Inverted Received Data Out	AC-coupled
13	RD+	Non-inverted Received Data Out	AC-coupled
14	VeeR	Module Receiver Ground	
15	VCCR	Module Receiver 3.3 V Supply	
16	VCCT	Module Transmitter 3.3 V Supply	
17	VeeT	Module Transmitter Ground	
18	TD+	Non-Inverted Transmit Data in	AC-coupled
19	TD-	Inverted Transmit Data in	AC-coupled
20	VeeT	Module Transmitter Ground	

## PIN OUT DRAWING

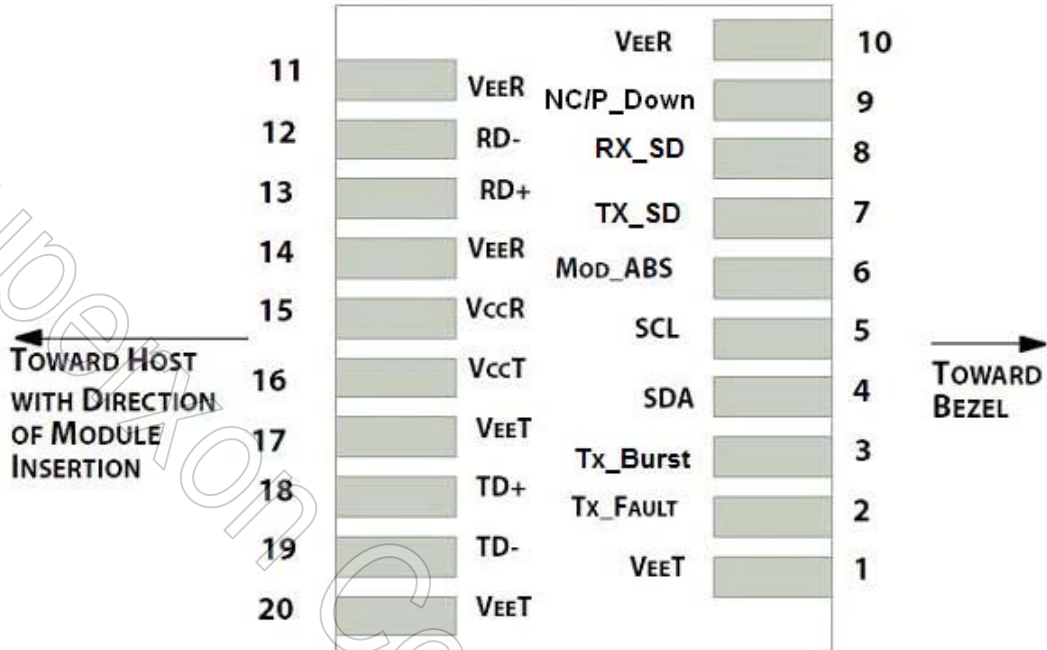


Figure 1 Pin Out Drawing

## TYPICAL INTERFACE CIRCUIT

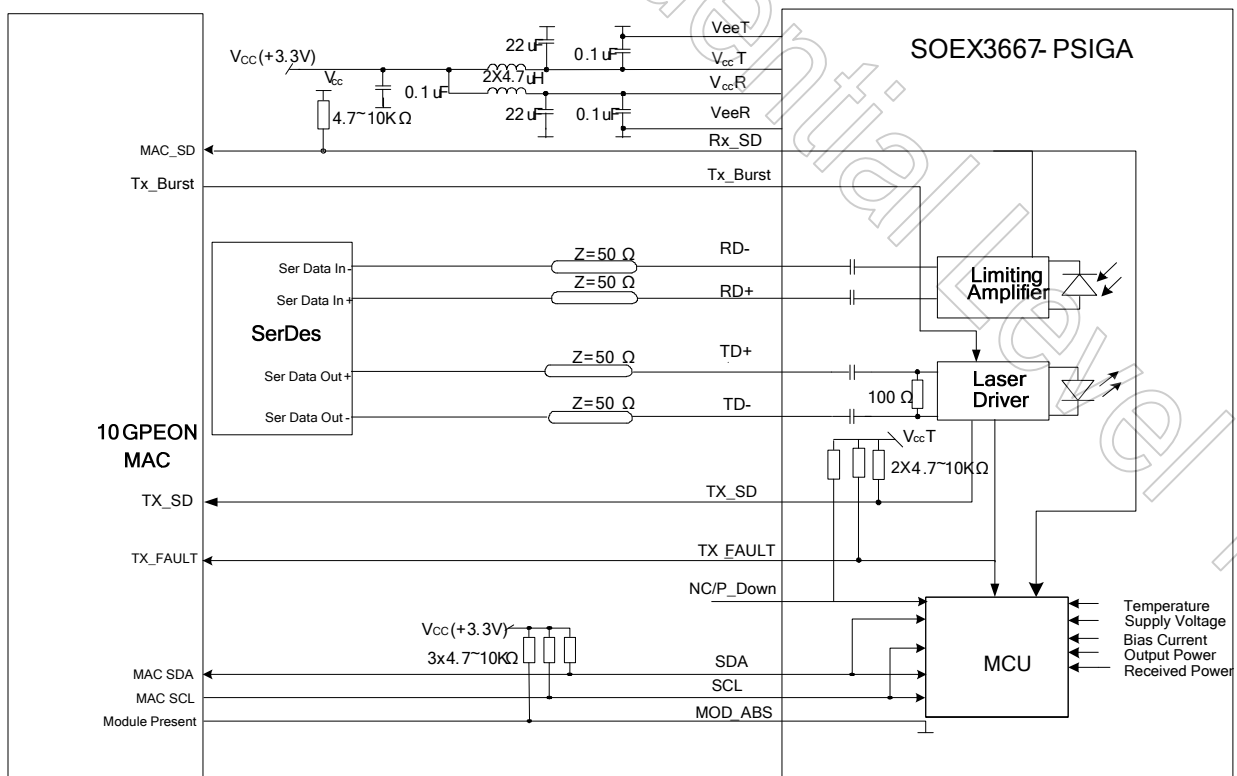


Figure 2 Typical Interface Circuit

PACKAGE OUTLINE

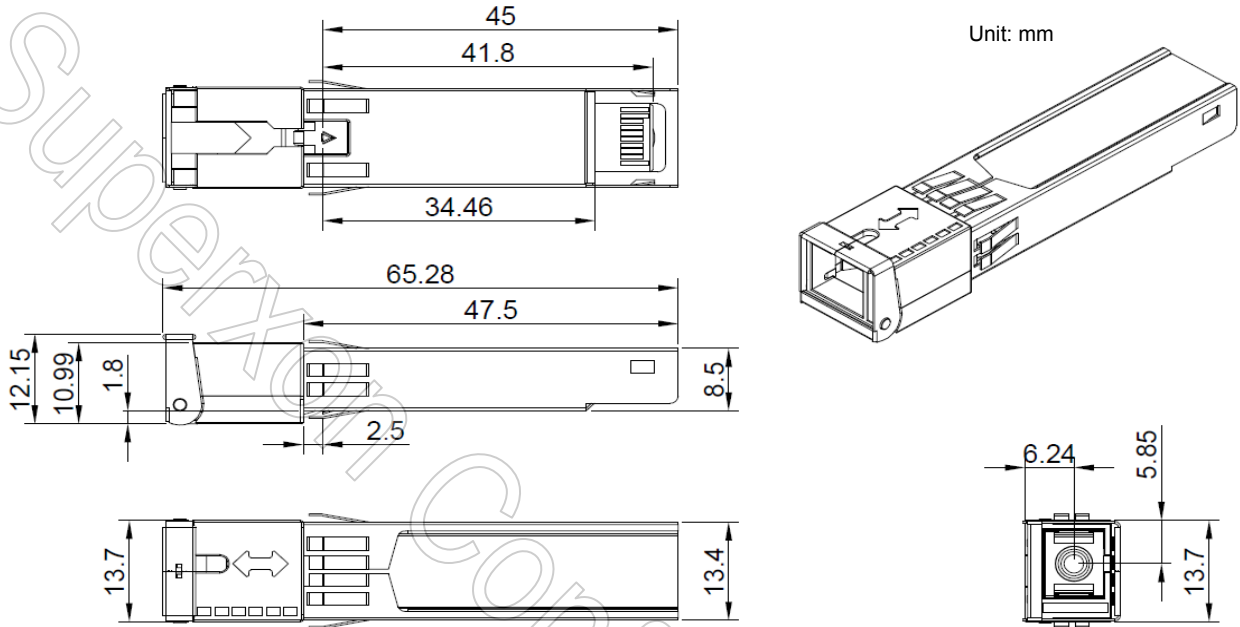


Figure 3 Package Outline

EEPROM INFORMATION

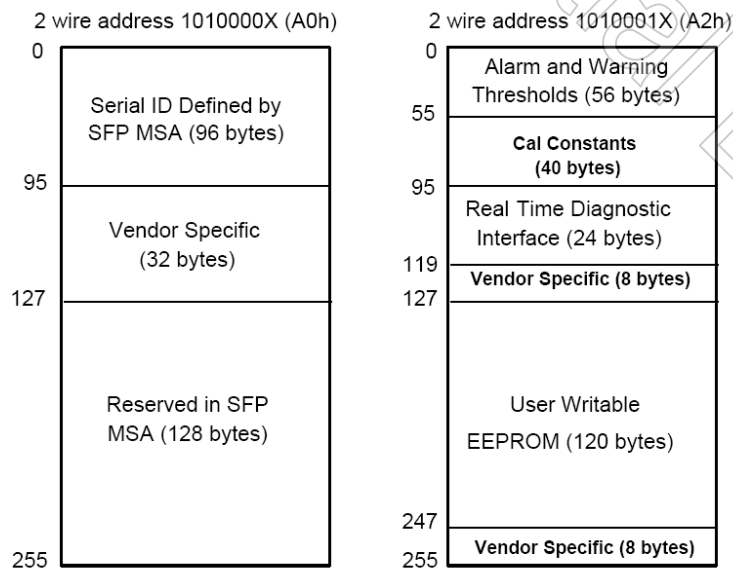


Figure 4 EEPROM Memory Map Specific Data Field Descriptions

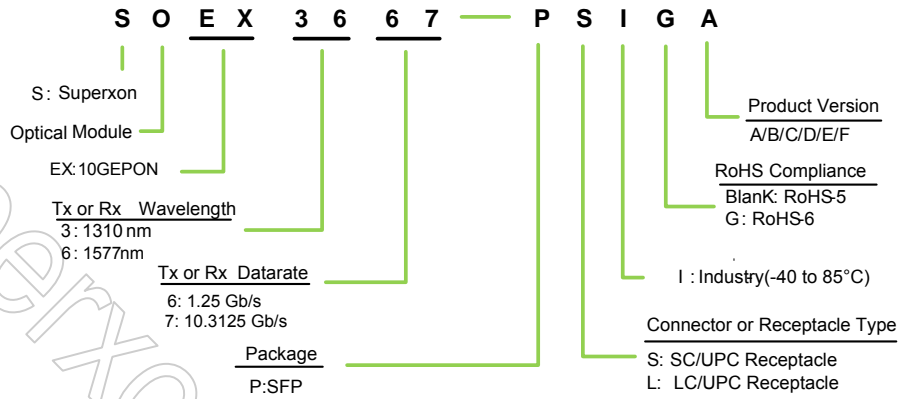
**DIGITAL DIAGNOSTIC MONITORING INTERFACE**

Five transceiver parameter values are monitored. The following table defines the monitored parameter's accuracy.

Parameter	Range	Accuracy	Calibration
Temperature	-40 to 85°C	±3°C	Internal
Voltage	3.0 to 3.6V	±3%	Internal
Bias Current	0 to 100mA	±10%	Internal
TX Power	0.62 to 5.62dBm	±3dB	Internal
RX Power monitor	-28.5 to -10dBm	±2dB	Internal

Superxon Confidential Level 1

**ORDERING INFORMATION**



**WARNINGS**

- **Handling Precautions:** This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- **Laser Safety:** Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

**LEGAL NOTES**

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